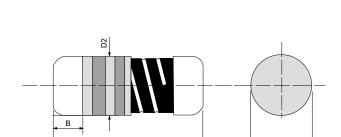


MM102 Metal Film MELF Resistor





Specifications Per

- IEC 60115-1
- EN140401-803

Features

- SMD enabled structure
- Excellent solderability termination
- Products meet RoHS requirements and do not contain substances of very high concern identified by European Chemicals Agency

DIMENSIONS

Туре	Body Length	Cap Diameter	Body Diameter	Soldering spot	Net Weight
	(L , mm)	(D1 , mm)	(D2 , mm)	(B, mm)	Per 1000 pcs
MM102	2.1 ± 0.1	1.1 ± 0.1	D1+0.02/-0.1	0.5 Min.	7 grams

■ GENERAL SPECIFICATIONS

Туре	Power Rating at 70°C	Maximum Working Voltage	Maximum Overload Voltage	Minimum Resistance	Maximum Resistance	Resistance Tolerance	Available Resistance Value
MM102 0.2W	150V	300V	10Ω	221ΚΩ	±0.5%	E-192	
			0.22Ω	2.2ΜΩ	±1%~±5%	E-24 / E-96	

Special sizes and specifications available on request.

PART NUMBER

Example: MM102F162RTKRTR3K0

MM102	F	162R	TKR	TR3K0
Туре	Tolerance*	Resistance	TCR	Packaging
	D (0.5%) F (1%) G (2%) J (5%)	162Ω 4-character code containing - 3 significant digits 1 letter multiplier OHM MULTIPLIER R = 1 K = 10 ³ M = 10 ⁶ G = 10 ⁹	50ppm 3-character code Insert the corresponding Code for the temperature coefficient available for the specific product. TKQ = ±25PPM TKR = ±50PPM TKS = ±100PPM	5-character code TR=Tape Reel MM102 3K0 = 3,000 6K0 = 6,000 10K = 10,000

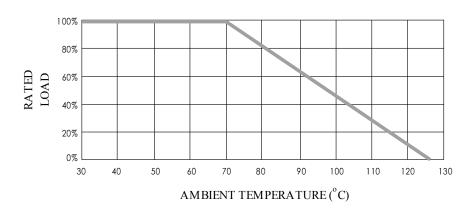
^{*} May not be applicable to all product types or to all resistance values. Please check with us before placing order.



MM102 Metal Film MELF Resistor



POWER DERATING CURVE

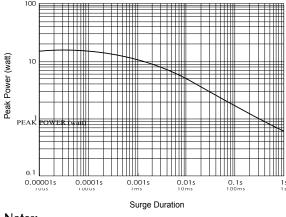


■ TECHNICAL SUMMARY

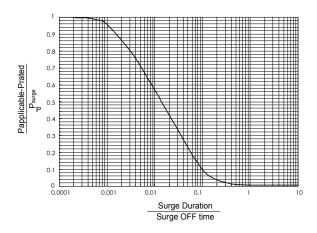
Characteristics	Limits		
Operating Temperature Range, °C	-55 ~ +125		
Temperature Coefficient, PPM / °C*	±1%, ±2%	±25, ±50, ±100	
Temperature Coefficient, PPM7 C	±5%	±100	
Dielectric Withstanding Voltage, VAC or DC	150		
Insulation Resistance, $M\Omega$	>104		
Tin Whisker (JESD201 Temperature Cycling & High Temp./Humidity Storage), µm	<5		

^{*} Not applicable to all resistance values. Please check with us regarding the PPM of specific resistance value(s).

■ SINGLE SURGE PERFORMANCE



■ SURGE POWER DERATING CURVE



Notes:

- SINGLE SURGE PERFORMANCE graph is good for NON REPETITIVE applications operating in an ambient temperature of 70°C or less. For temperatures above 70°C, the graph power must be derated further linearly down to zero at 125°C.
- To determine applicable surge power in continuous-surge applications:
- 1. Identify allowable duration and peak power P_{surge} of single surge;
- 2. Determine ratio of surge duration/surge OFF time in application;
- 3. Calculate Papplicable backwardly according to Y-axis of SURGE POWER DERATING CURVE.

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MM102 Metal Film MELF Resistor



■ PERFORMANCE SPECIFICATIONS

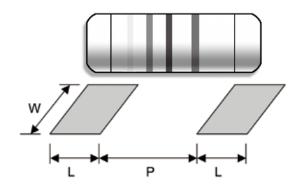
Characteristics	aracteristics Test Conditions			Limits		
	IEC 60115-1 4.13 5 seconds 2.5x rated voltage (not over max. overload voltage)		0.22Ω to 221KΩ			
Short Time Overload			>221KKΩ			
	IEC 60115-1 4.25.1 Rated load (not over max. working voltage) with 1.5 hours ON, 0.5 hours OFF, at (70±2)°C		0.22Ω to 221KΩ			
Load Life 1,000 hours			Ω	± 2.0% ± 3.0%		
	IEC 60115-1 4.24	22 TIGE ± 0.070				
Load Life In Humidity	56 days rated load (not over max. working voltage) at (40±2)°C and (93±3)% relative humidity	± 2.5%				
	IEC 60115-1 4.37		0.22Ω to < 100KΩ			
Load Life In Humidity (accelerated mode)	1,000 hours at 85°C and 85% relative humidity with 0.1x rated voltage	100KΩ to 221K		± 3.5%		
(doodlorated mode)	(not over 100V)	>221ΚΩ		± 5.0%		
Periodic Electric Overload	IEC 60115-1 4.39 3.9x rated voltage (not over max. overload voltage) with 0.1s ON, 2.5s OFF for 1,000 cycles		± 1.5%			
Resistance To Soldering Heat	IEC 60115-1 4.18.2 Dip the resistor into a solder bath measured (260±5)°C and hold it for a 10±1 seconds		± 0.5%			
			0.22Ω to < 10	Ω ± 2.0		
		85°C	10Ω to 221Kg			
Thermal Endurance	IEC 60115-1 4.25.3 1,000 hours at without load	125°C	>221KΩ	± 1.5		
			0.22Ω to < 10			
			10Ω to 221KΩ	$\frac{2}{\pm 2.0}$		
	IEC 60115-1 4.19			±0.59		
Thermal Shock	-55°C 30minutes, +125°C 30minutes	,		±1.59		
Single pulse high voltage overload	 IEC 60115-1 4.27 5 pulses of 1.2/50μs at 10x rated voltage (not over max. overload voltage) with interval of 12 sec. 10 pulses of 10/700μs at 10x rated voltage (not over max. overload voltage) with interval of 60 sec. 	± 1.0% ± 1.0%				
Electrostatic discharge (Human body model)	IEC 60115-1 4.38 3 positive & 3 negative discharges with 1.5KV (For continuous surge application please see Surge Performance paragraph)	± 2.0%				
Climatic test	IEC 60115-1 4.23 4.23.2 - dry heat: 16 hours 125°C 4.23.3 - damp heat: 24 hours 55°C with 95% relative humidity 4.23.4 - cold: 2 hours -55°C 4.23.5 - negative air pressure: 2 hour 8.5KPa at (25±10)°C 4.23.6 - damp heat cyclic: 5 days 55°C with 95% relative humidity 4.23.7 - DC load: rated voltage at -55°C and 125°C each 1 Min.	± 2.0%				
Solderability	IEC 60115-1 4.17.2 Solder area covered after (235±3)°C/(2±0.2) seconds with flux applied	> 95% Covered				
Vibration	IEC 60115-1 4.22 Six hours in each parallel and axial direction with a simple harmonic motion having an amplitude of 1.52mm and 10 to 2,000 Hz.	±1.0%				
Bending test	IEC 60115-1 4.33 Pressing depth 2mm, 3 times		± 0.25%			
Flammability	IEC 60115-1 4.35 Needle flame test 10s	No burning after 30s				



WW102 Metal Film MELF Resistor



■ SUGGESTED PAD LAYOUT



Туре	Soldering Mode	Pad Length (L, mm, Min.)	Pad Spacing (P, mm)	Pad Width (W, mm, Min.)	
MM102	Reflow	0.8	1.1 ± 0.05	1.3	
	Wave	1.2	0.7 ± 0.05	1.5	

For better heat dissipation / lower heat resistance, increase W & L.

■ COVER TAPE PEELING SPECIFICATION

Recommended peeling force: 50gf±5gf

